

# SN65HVD1781A-Q1 Fault-Protected RS-485 Transceivers With 3.3-V to 5-V Operation

## 1 Features

- Qualified for automotive applications
- AEC-Q100 Qualified with the following results
  - Device temperature grade 1: –40°C to 125°C ambient operating temperature range
  - Device HBM ESD classification level H2
  - Device CDM ESG classification level C3B
- [Functional Safety-Capable](#)
  - [Documentation available to aid functional safety system design](#)
- Bus-pin fault protection to: >  $\pm 70$  V
- Operation with 3.3-V to 5-V supply range
- $\pm 16$ -kV HBM protection on bus pins
- Reduced unit load for up to 320 nodes
- Failsafe receiver for open-circuit, short-circuit and idle-bus conditions
- Low power consumption
  - Low standby supply current, 1  $\mu$ A maximum
  - $I_{CC}$  4-mA Quiescent during operation
- Pin-compatible with industry-standard SN75176
- Signaling rates up to 1 Mbps

## 2 Applications

- [Infotainment](#), clusters
- [HMI](#) and [displays](#)
- [Media interface](#)
- [Head unit](#)

## 3 Description

The device is designed to survive overvoltage faults such as direct shorts to power supplies, mis-wiring faults, connector failures, cable crushes, and tool mis-applications. It is also robust to ESD events, with high levels of protection to the human-body-model specification.

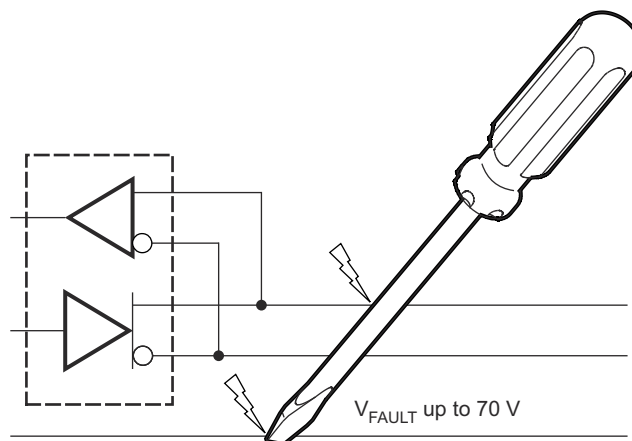
The SN65HVD1781A-Q1 combines a differential driver and a differential receiver, which operate from a single power supply. The driver differential outputs and the receiver differential inputs are connected internally to form a bus port suitable for half-duplex (two-wire bus) communication. This port features a wide common-mode voltage range, making the device suitable for multipoint applications over long cable runs. The device is characterized from –40°C to 125°C. The SN65HVD1781A-Q1 device is pin-compatible with the industry-standard SN75176 transceiver, making it a drop-in upgrade in most systems.

The device is fully compliant with ANSI TIA/EIA 485-A with a 5-V supply and can operate with a 3.3-V supply with reduced driver output voltage for low-power applications. For applications where operation is required over an extended common-mode voltage range, see the SN65HVD1785 ([SLLS872](#)) data sheet.

### Device Information

| PART NUMBER     | PACKAGE <sup>(1)</sup> | BODY SIZE (NOM)   |
|-----------------|------------------------|-------------------|
| SN65HVD1781A-Q1 | SOIC                   | 4.90 mm x 3.91 mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.



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### Simplified Schematic



An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, intellectual property matters and other important disclaimers. PRODUCTION DATA.

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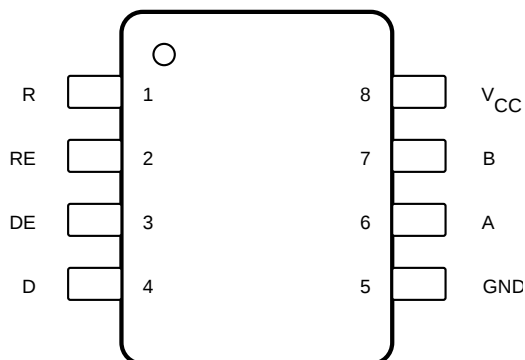
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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision * (May 2017) to Revision A (February 2022) | Page     |
|------------------------------------------------------------------|----------|
| • Added <i>Feature</i> Functional Safety-Capable.....            | <b>1</b> |

## 5 Pin Configuration and Functions



**Figure 5-1. D (SOIC) Package, 8-Pin, Top View**

**Table 5-1. Pin Functions**

| PIN             |     | TYPE                | DESCRIPTION                                          |
|-----------------|-----|---------------------|------------------------------------------------------|
| NAME            | NO. |                     |                                                      |
| A               | 6   | Bus I/O             | Driver output or receiver input (complementary to B) |
| B               | 7   | Bus I/O             | Driver output or receiver input (complementary to A) |
| D               | 4   | Digital input       | Driver data input                                    |
| DE              | 3   | Digital input       | Driver enable, active high                           |
| GND             | 5   | Reference potential | Local device ground                                  |
| R               | 1   | Digital output      | Receive data output                                  |
| RE              | 2   | Digital input       | Receiver enable, active low                          |
| V <sub>CC</sub> | 8   | Supply              | 3.15-V-to-5.5-V supply                               |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

See Note (1).

|                  |                                                       | MIN             | MAX                   | UNIT     |
|------------------|-------------------------------------------------------|-----------------|-----------------------|----------|
| V <sub>CC</sub>  | Supply voltage                                        | –0.5            | 7                     | V        |
|                  | Voltage range at bus pins                             | A, B pins       |                       | –70 70 V |
|                  | Input voltage range at any logic pin                  | –0.3            | V <sub>CC</sub> + 0.3 | V        |
|                  | Transient overvoltage pulse through 100 Ω per TIA-485 | –70             | 70                    | V        |
|                  | Receiver output current                               | –24             | 24                    | mA       |
|                  | Continuous total power dissipation                    | See Section 6.7 |                       |          |
| T <sub>J</sub>   | Junction temperature                                  |                 | 170                   | °C       |
| T <sub>stg</sub> | Storage temperature                                   | –40             | 150                   | °C       |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 6.2 ESD Ratings—AEC

|                    |                         |                                                         | VALUE                 | UNIT   |
|--------------------|-------------------------|---------------------------------------------------------|-----------------------|--------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human-body model (HBM), per AEC Q100-002 <sup>(1)</sup> | Bus terminals and GND | ±16000 |
|                    |                         |                                                         | All pins              | ±4000  |
|                    |                         | Charged-device model (CDM), per AEC Q100-011            |                       | ±1500  |

- (1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

### 6.3 ESD Ratings—IEC

|                    |                         |                                          | VALUE                 | UNIT     |
|--------------------|-------------------------|------------------------------------------|-----------------------|----------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human body model (HBM), per IEC 60749-26 | Bus terminals and GND | ±16000 V |

### 6.4 Recommended Operating Conditions

|                   |                                                                              | MIN          | NOM | MAX             | UNIT |
|-------------------|------------------------------------------------------------------------------|--------------|-----|-----------------|------|
| V <sub>CC</sub>   | Supply voltage                                                               | 3.15         | 5   | 5.5             | V    |
| V <sub>I</sub>    | Input voltage at any bus terminal (separately or common mode) <sup>(1)</sup> | –7           |     | 12              | V    |
| V <sub>IH</sub>   | High-level input voltage (driver, driver enable, and receiver enable inputs) | 2            |     | V <sub>CC</sub> | V    |
| V <sub>IL</sub>   | Low-level input voltage (driver, driver enable, and receiver enable inputs)  | 0            |     | 0.8             | V    |
| V <sub>ID</sub>   | Differential input voltage                                                   | –12          |     | 12              | V    |
| I <sub>O</sub>    | Output current, driver                                                       | –60          |     | 60              | mA   |
|                   | Output current, receiver                                                     | –8           |     | 8               | mA   |
| R <sub>L</sub>    | Differential load resistance                                                 | 54           | 60  |                 | Ω    |
| C <sub>L</sub>    | Differential load capacitance                                                |              | 50  |                 | pF   |
| 1/t <sub>UI</sub> | Signaling rate                                                               |              |     | 1               | Mbps |
| T <sub>A</sub>    | Operating free-air temperature (See the Section 6.5 table)                   | 5-V supply   | –40 | 105             | °C   |
|                   |                                                                              | 3.3-V supply | –40 | 125             |      |
| T <sub>J</sub>    | Junction Temperature                                                         | –40          |     | 150             | °C   |

- (1) By convention, the least positive (most negative) limit is designated as minimum in this data sheet.

## 6.5 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              |                    | SN65HVD1781A-Q1 | UNIT |
|-------------------------------|----------------------------------------------|--------------------|-----------------|------|
|                               |                                              |                    | D (SOIC)        |      |
|                               |                                              |                    | 8 PINS          |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | JEDEC high-K model | 97.7            | °C/W |
|                               |                                              | JEDEC low-K model  | 242             | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    |                    | 39.6            | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         |                    | 39.2            | °C/W |
| ψ <sub>JT</sub>               | Junction-to-top characterization parameter   |                    | 3.8             | °C/W |
| ψ <sub>JB</sub>               | Junction-to-board characterization parameter |                    | 38.5            | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance |                    | N/A             | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.6 Electrical Characteristics

over recommended operating conditions (unless otherwise noted)

| PARAMETER                                                 |                                                                                                                | TEST CONDITIONS                                                                                                      |                                                                            | MIN                       | TYP                | MAX  | UNIT |
|-----------------------------------------------------------|----------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------|---------------------------|--------------------|------|------|
| V <sub>OD</sub>                                           | Driver differential output voltage magnitude                                                                   | R <sub>L</sub> = 60 Ω, 4.75 V ≤ V <sub>CC</sub> 375 Ω on each output to −7 V to 12 V, See <a href="#">Figure 7-1</a> | T <sub>A</sub> < 85°C                                                      | 1.5                       |                    |      | V    |
|                                                           |                                                                                                                |                                                                                                                      | T <sub>A</sub> < 125°C                                                     | 1.4                       |                    |      |      |
|                                                           |                                                                                                                | R <sub>L</sub> = 54 Ω, 4.75 V ≤ V <sub>CC</sub> ≤ 5.25 V                                                             | T <sub>A</sub> < 85°C                                                      | 1.7                       | 2                  |      |      |
|                                                           |                                                                                                                |                                                                                                                      | T <sub>A</sub> < 125°C                                                     | 1.5                       |                    |      |      |
|                                                           |                                                                                                                | R <sub>L</sub> = 54 Ω, 3.15 V ≤ V <sub>CC</sub> ≤ 3.45 V                                                             | 0.8                                                                        | 1                         |                    |      |      |
| R <sub>L</sub> = 100 Ω, 4.75 V ≤ V <sub>CC</sub> ≤ 5.25 V | T <sub>A</sub> < 85°C                                                                                          | 2.2                                                                                                                  | 2.5                                                                        |                           |                    |      |      |
|                                                           | T <sub>A</sub> < 125°C                                                                                         | 2                                                                                                                    |                                                                            |                           |                    |      |      |
| Δ V <sub>OD</sub>                                         | Change in magnitude of driver differential output voltage                                                      | R <sub>L</sub> = 54 Ω                                                                                                |                                                                            | −50                       | 0                  | 50   | mV   |
| V <sub>OC(SS)</sub>                                       | Steady-state common-mode output voltage                                                                        |                                                                                                                      |                                                                            | 1                         | V <sub>CC</sub> /2 | 3    | V    |
| ΔV <sub>OC</sub>                                          | Change in differential driver output common-mode voltage                                                       |                                                                                                                      |                                                                            | −50                       | 0                  | 50   | mV   |
| V <sub>OC(PP)</sub>                                       | Peak-to-peak driver common-mode output voltage                                                                 | Center of two 27-Ω load resistors, See <a href="#">Figure 7-2</a>                                                    |                                                                            | 500                       |                    |      | mV   |
| C <sub>OD</sub>                                           | Differential output capacitance                                                                                |                                                                                                                      |                                                                            | 23                        |                    |      | pF   |
| V <sub>IT+</sub>                                          | Positive-going receiver differential input voltage threshold                                                   |                                                                                                                      |                                                                            | −100                      |                    | −35  | mV   |
| V <sub>IT−</sub>                                          | Negative-going receiver differential input voltage threshold                                                   |                                                                                                                      |                                                                            | −180                      |                    | −150 | mV   |
| V <sub>HYS</sub>                                          | Receiver differential input voltage threshold hysteresis (V <sub>IT+</sub> − V <sub>IT−</sub> ) <sup>(1)</sup> |                                                                                                                      |                                                                            | 30                        |                    | 50   | mV   |
| V <sub>OH</sub>                                           | Receiver high-level output voltage                                                                             | I <sub>OH</sub> = −8 mA                                                                                              |                                                                            | 2.4 V <sub>CC</sub> − 0.3 |                    |      | V    |
| V <sub>OL</sub>                                           | Receiver low-level output voltage                                                                              | I <sub>OL</sub> = 8 mA                                                                                               | T <sub>A</sub> < 85°C                                                      | 0.2                       |                    | 0.4  | V    |
|                                                           |                                                                                                                |                                                                                                                      | T <sub>A</sub> < 125°C                                                     | 0.5                       |                    |      |      |
| I <sub>I(LOGIC)</sub>                                     | Driver input, driver enable, and receiver enable input current                                                 |                                                                                                                      |                                                                            | −50                       |                    | 50   | μA   |
| I <sub>OZ</sub>                                           | Receiver output high-impedance current                                                                         | V <sub>O</sub> = 0 V or V <sub>CC</sub> , $\overline{\text{RE}}$ at V <sub>CC</sub>                                  |                                                                            | −1                        |                    | 1    | μA   |
| I <sub>OS</sub>                                           | Driver short-circuit output current                                                                            |                                                                                                                      |                                                                            | −200                      |                    | 200  | mA   |
| I <sub>I(BUS)</sub>                                       | Bus input current (disabled driver)                                                                            | V <sub>CC</sub> = 3.15 to 5.5 V or V <sub>CC</sub> = 0 V, DE at 0 V                                                  | V <sub>I</sub> = 12 V                                                      | 75                        |                    | 100  | μA   |
|                                                           |                                                                                                                |                                                                                                                      | V <sub>I</sub> = −7 V                                                      | −60 −40                   |                    |      |      |
| I <sub>CC</sub>                                           | Supply current (quiescent)                                                                                     | Driver and receiver enabled                                                                                          | DE = V <sub>CC</sub> , RE = GND, no load                                   | 4                         |                    | 6    | mA   |
|                                                           |                                                                                                                | Driver enabled, receiver disabled                                                                                    | DE = V <sub>CC</sub> , RE = V <sub>CC</sub> , no load                      | 3                         |                    | 5    |      |
|                                                           |                                                                                                                | Driver disabled, receiver enabled                                                                                    | DE = GND, RE = GND, no load                                                | 2                         |                    | 4    |      |
|                                                           | Driver and receiver disabled, standby mode                                                                     |                                                                                                                      | DE = GND, D = open, RE = V <sub>CC</sub> , no load, T <sub>A</sub> < 85°C  | 0.15                      |                    | 1    | μA   |
|                                                           |                                                                                                                |                                                                                                                      | DE = GND, D = open, RE = V <sub>CC</sub> , no load, T <sub>A</sub> < 125°C |                           |                    | 12   |      |
| Supply current (dynamic)                                  |                                                                                                                | See the <a href="#">Section 6.9</a> section                                                                          |                                                                            |                           |                    |      |      |

(1) Ensured by design. Not production tested.

## 6.7 Power Dissipation Ratings

| PARAMETER                                             | TEST CONDITIONS                                                                                                                                                                             | VALUE | UNIT |
|-------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|------|
| P <sub>D</sub> Power dissipation                      | V <sub>CC</sub> = 3.6 V, T <sub>J</sub> = 150°C, R <sub>L</sub> = 300 Ω,<br>C <sub>L</sub> = 50 pF (driver), C <sub>L</sub> = 15 pF (receiver)<br>3.3-V supply, unterminated <sup>(1)</sup> | 75    | mW   |
|                                                       | V <sub>CC</sub> = 3.6 V, T <sub>J</sub> = 150°C, R <sub>L</sub> = 100 Ω,<br>C <sub>L</sub> = 50 pF (driver), C <sub>L</sub> = 15 pF (receiver)<br>3.3-V supply, RS-422 load <sup>(1)</sup>  | 95    |      |
|                                                       | V <sub>CC</sub> = 3.6 V, T <sub>J</sub> = 150°C, R <sub>L</sub> = 54 Ω,<br>C <sub>L</sub> = 50 pF (driver), C <sub>L</sub> = 15 pF (receiver)<br>3.3-V supply, RS-485 load <sup>(1)</sup>   | 115   |      |
|                                                       | V <sub>CC</sub> = 5.5 V, T <sub>J</sub> = 150°C, R <sub>L</sub> = 300 Ω,<br>C <sub>L</sub> = 50 pF (driver), C <sub>L</sub> = 15 pF (receiver)<br>5-V supply, unterminated <sup>(1)</sup>   | 290   |      |
|                                                       | V <sub>CC</sub> = 5.5 V, T <sub>J</sub> = 150°C, R <sub>L</sub> = 100 Ω,<br>C <sub>L</sub> = 50 pF (driver), C <sub>L</sub> = 15 pF (receiver)<br>5-V supply, RS-422 load <sup>(1)</sup>    | 320   |      |
|                                                       | V <sub>CC</sub> = 5.5 V, T <sub>J</sub> = 150°C, R <sub>L</sub> = 54 Ω,<br>C <sub>L</sub> = 50 pF (driver), C <sub>L</sub> = 15 pF (receiver)<br>5-V supply, RS-485 load <sup>(1)</sup>     | 400   |      |
| T <sub>SD</sub> Thermal-shutdown junction temperature |                                                                                                                                                                                             | 170   | °C   |

(1) Driver and receiver enabled, 50% duty cycle square-wave signal at signaling rate: 1 Mbps.

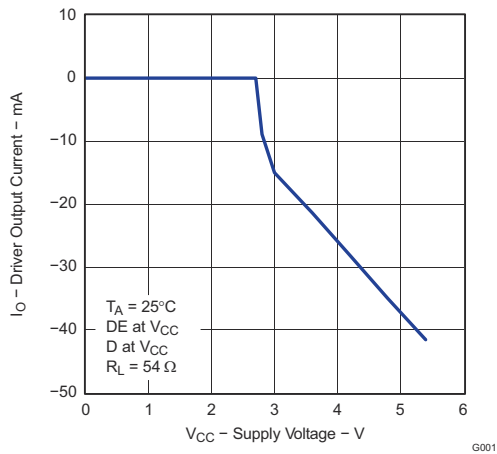
## 6.8 Switching Characteristics

over recommended operating conditions (unless otherwise noted)

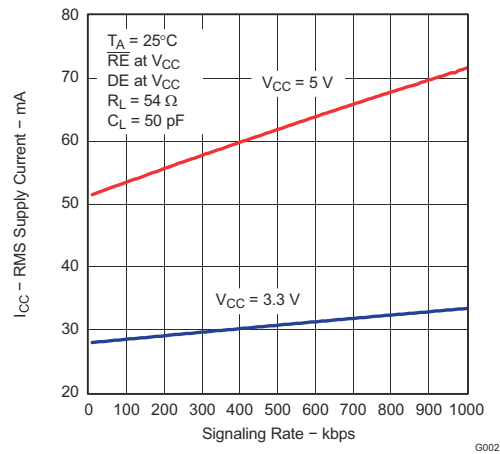
| PARAMETER                                                                              |                                                                             | TEST CONDITIONS                                                               |                                                               | MIN | TYP | MAX | UNIT |
|----------------------------------------------------------------------------------------|-----------------------------------------------------------------------------|-------------------------------------------------------------------------------|---------------------------------------------------------------|-----|-----|-----|------|
| DRIVER                                                                                 |                                                                             |                                                                               |                                                               |     |     |     |      |
| t <sub>r</sub> , t <sub>f</sub>                                                        | Driver differential output rise/fall time                                   | R <sub>L</sub> = 54 Ω, C <sub>L</sub> = 50 pF, See <a href="#">Figure 7-3</a> |                                                               | 50  |     | 300 | ns   |
| t <sub>PHL</sub> , t <sub>PLH</sub>                                                    | Driver propagation delay                                                    | R <sub>L</sub> = 54 Ω, C <sub>L</sub> = 50 pF, See <a href="#">Figure 7-3</a> |                                                               |     |     | 200 | ns   |
| t <sub>SK(P)</sub>                                                                     | Driver differential output pulse skew,  t <sub>PHL</sub> – t <sub>PLH</sub> | R <sub>L</sub> = 54 Ω, C <sub>L</sub> = 50 pF, See <a href="#">Figure 7-3</a> |                                                               |     |     | 25  | ns   |
| t <sub>PHZ</sub> , t <sub>PLZ</sub>                                                    | Driver disable time                                                         | See <a href="#">Figure 7-4</a> and <a href="#">Figure 7-5</a>                 |                                                               |     |     | 3   | μs   |
| t <sub>PZH</sub> , t <sub>PZL</sub>                                                    | Driver enable time                                                          | Receiver enabled                                                              | See <a href="#">Figure 7-4</a> and <a href="#">Figure 7-5</a> |     |     | 300 | ns   |
|                                                                                        |                                                                             | Receiver disabled                                                             |                                                               |     |     | 10  | μs   |
| RECEIVER                                                                               |                                                                             |                                                                               |                                                               |     |     |     |      |
| t <sub>r</sub> , t <sub>f</sub>                                                        | Receiver output rise/fall time <sup>(1)</sup>                               | C <sub>L</sub> = 15 pF, See <a href="#">Figure 7-6</a>                        |                                                               |     | 4   | 15  | ns   |
| t <sub>PHL</sub> , t <sub>PLH</sub>                                                    | Receiver propagation delay time                                             | C <sub>L</sub> = 15 pF, See <a href="#">Figure 7-6</a>                        |                                                               |     | 100 | 200 | ns   |
| t <sub>SK(P)</sub>                                                                     | Receiver output pulse skew,  t <sub>PHL</sub> – t <sub>PLH</sub>            | C <sub>L</sub> = 15 pF, See <a href="#">Figure 7-6</a>                        |                                                               |     | 6   | 20  | ns   |
| t <sub>PLZ</sub> , t <sub>PHZ</sub>                                                    | Receiver disable time <sup>(1)</sup>                                        | Driver enabled, See <a href="#">Figure 7-7</a>                                |                                                               |     | 15  | 100 | ns   |
| t <sub>PZL(1)</sub> , t <sub>PZH(1)</sub><br>t <sub>PZL(2)</sub> , t <sub>PZH(2)</sub> | Receiver enable time                                                        | Driver enabled, See <a href="#">Figure 7-7</a>                                |                                                               |     | 80  | 300 | ns   |
|                                                                                        |                                                                             | Driver disabled, See <a href="#">Figure 7-8</a>                               |                                                               |     | 3   | 9   | μs   |

(1) Specified by design. Not production tested.

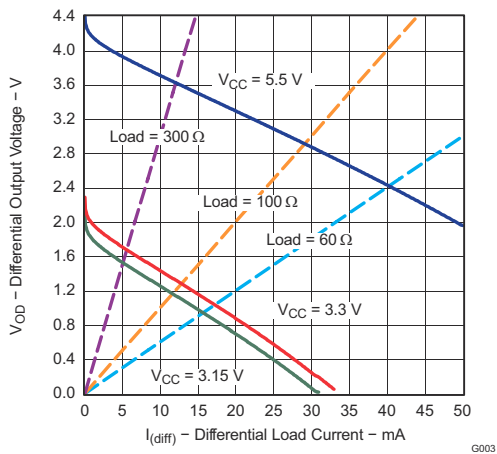
## 6.9 Typical Characteristics



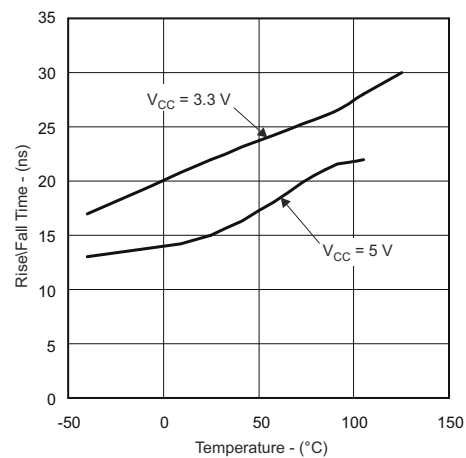
**Figure 6-1. Driver Output Current vs Supply Voltage**



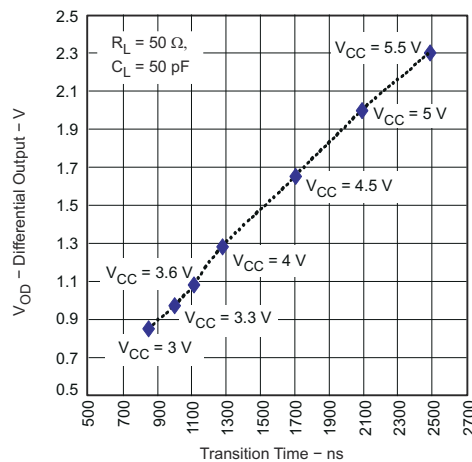
**Figure 6-2. RMS Supply Current vs Signaling Rate**



**Figure 6-3. Differential Output Voltage vs Differential Load Current**



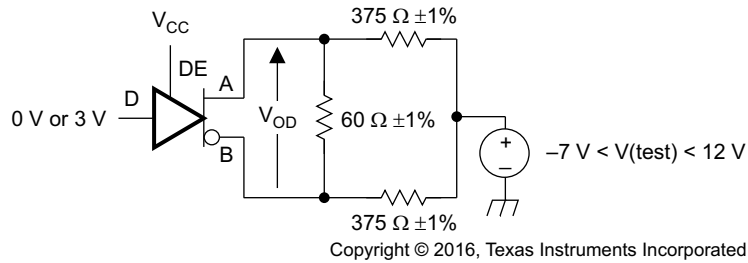
**Figure 6-4. Rise and Fall Time**



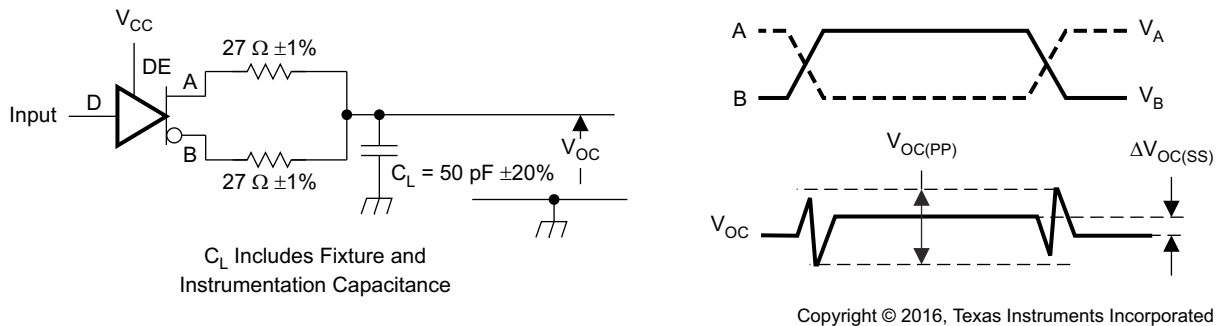
**Figure 6-5. Differential Output Amplitude and Transition Time vs Supply Voltage**

## 7 Parameter Measurement Information

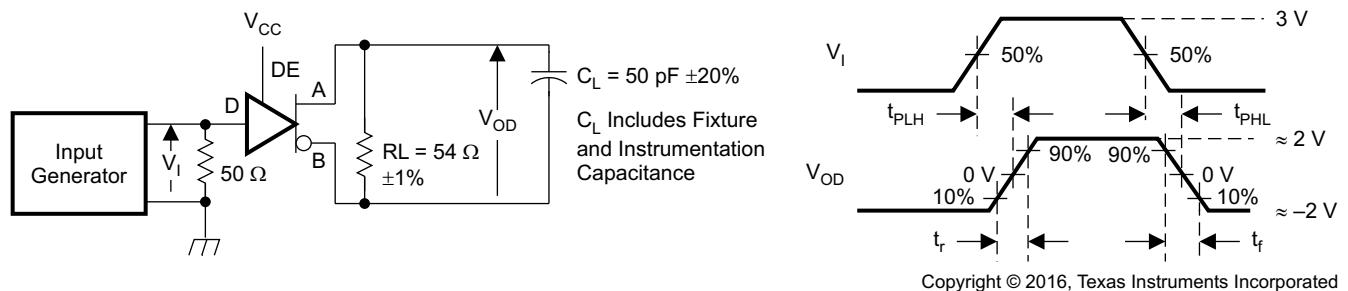
Input generator rate is 100 kbps, 50% duty cycle, rise and fall times less than 6 ns, output impedance 50  $\Omega$ .



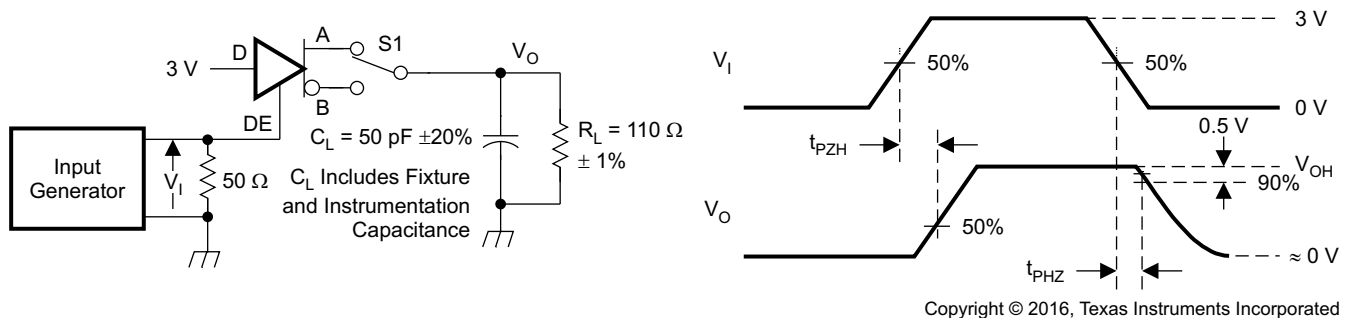
**Figure 7-1. Measurement of Driver Differential Output Voltage With Common-Mode Load**



**Figure 7-2. Measurement of Driver Differential and Common-Mode Output With RS-485 Load**

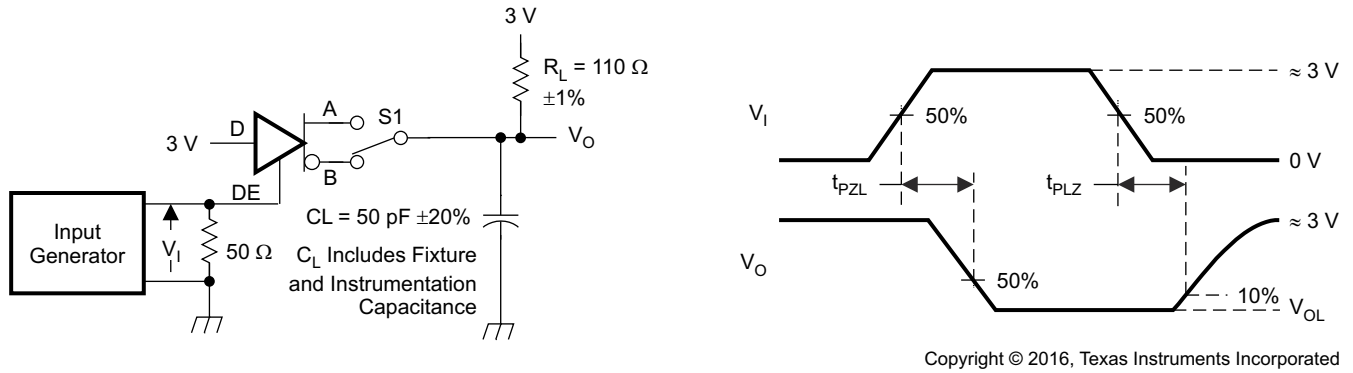


**Figure 7-3. Measurement of Driver Differential Output Rise and Fall Times and Propagation Delays**



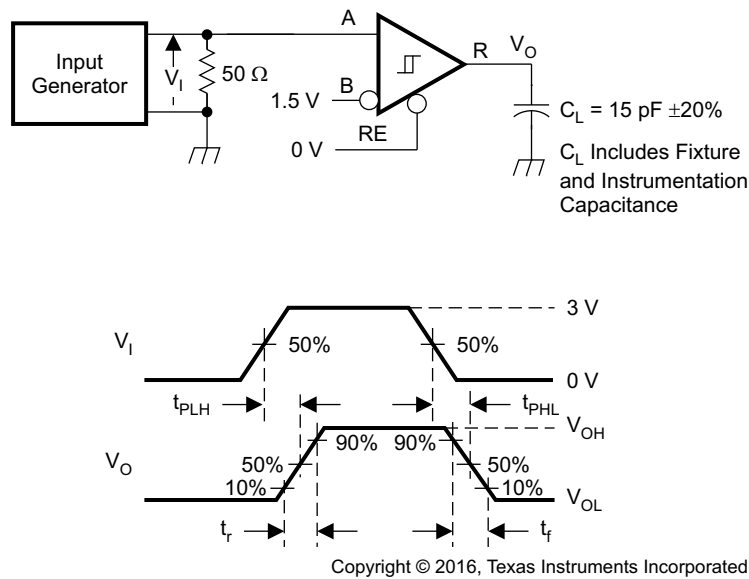
D at 3 V to test non-inverting output, D at 0 V to test inverting output.

**Figure 7-4. Measurement of Driver Enable and Disable Times With Active High Output and Pulldown Load**

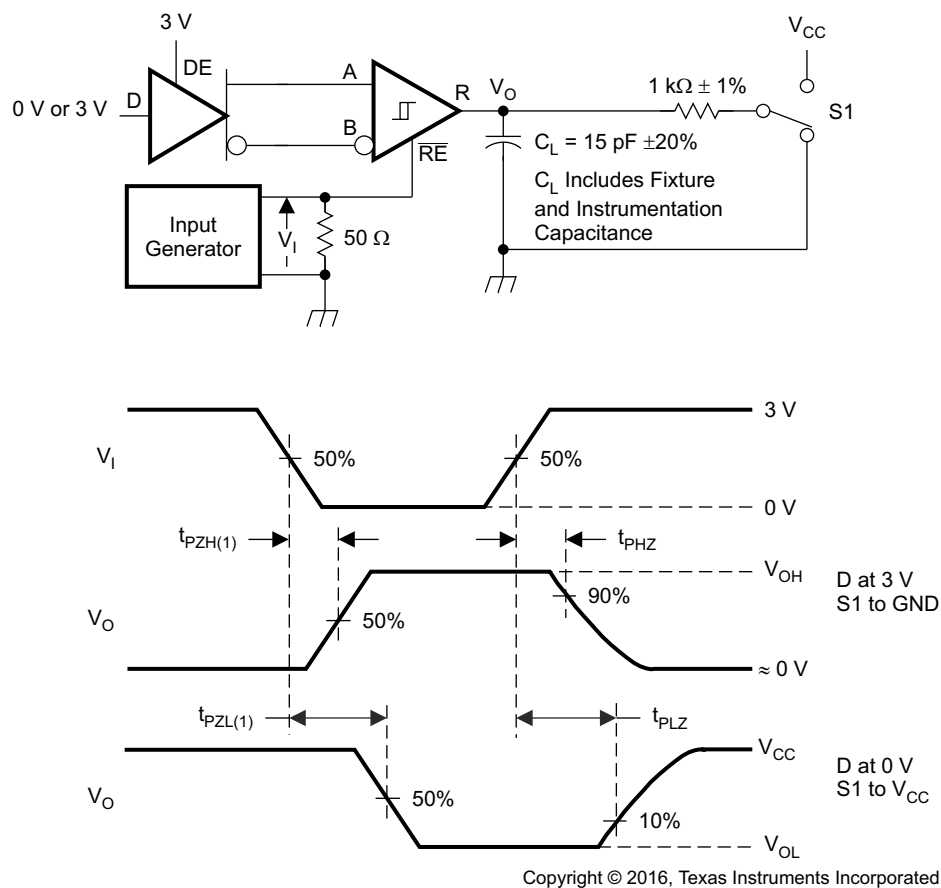


D at 0 V to test non-inverting output, D at 3 V to test inverting output.

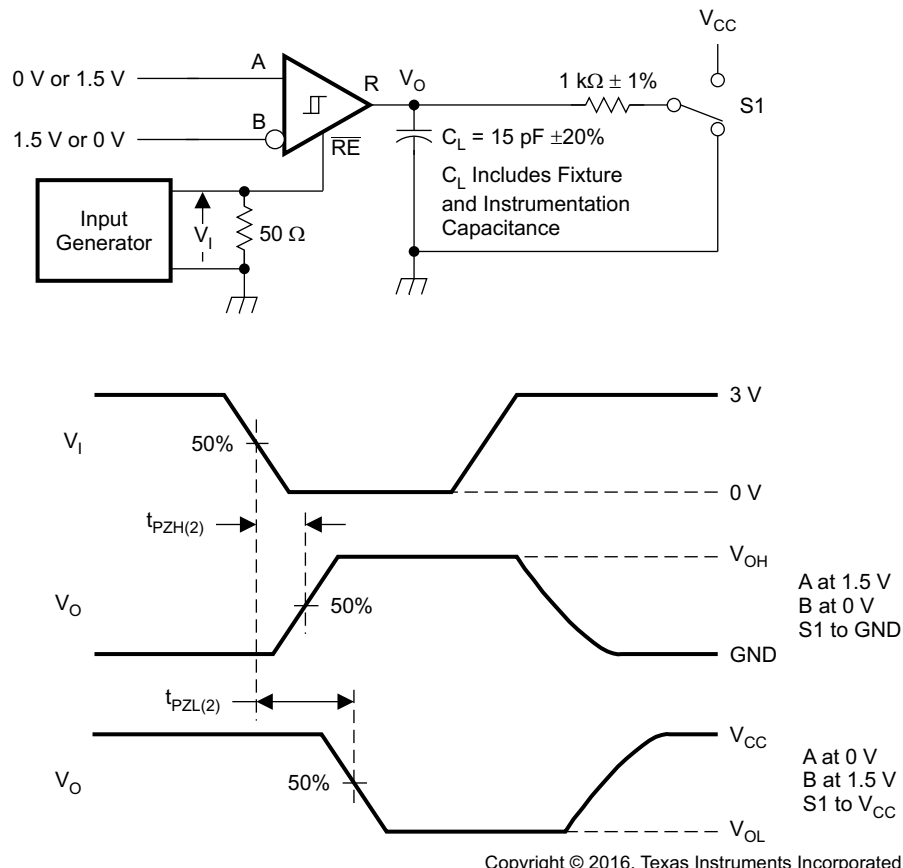
**Figure 7-5. Measurement of Driver Enable and Disable Times With Active-Low Output and Pullup Load**



**Figure 7-6. Measurement of Receiver Output Rise and Fall Times and Propagation Delays**



**Figure 7-7. Measurement of Receiver Enable and Disable Times With Driver Enabled**



**Figure 7-8. Measurement of Receiver Enable Times With Driver Disabled**



## 8.4 Device Functional Modes

When the driver enable pin, DE, is logic high, the differential outputs A and B follow the logic states at data input D. A logic high at D causes A to turn high and B to turn low. In this case the differential output voltage defined as  $V_{OD} = V_A - V_B$  is positive. When D is low, the output states reverse, B turns high, A becomes low, and  $V_{OD}$  is negative.

When DE is low, both outputs turn high-impedance. In this condition the logic state at D is irrelevant. The DE pin has an internal pull-down resistor to ground, thus when left open the driver is disabled (high-impedance) by default. The D pin has an internal pull-up resistor to  $V_{CC}$ , thus, when left open while the driver is enabled, output A turns high and B turns low.

**Table 8-1. Driver Function Table**

| INPUT | ENABLE | OUTPUTS |   | DRIVER STATE                       |
|-------|--------|---------|---|------------------------------------|
| D     | DE     | A       | B |                                    |
| H     | H      | H       | L | Actively drive bus High            |
| L     | H      | L       | H | Actively drive bus Low             |
| X     | L      | Z       | Z | Driver disabled                    |
| X     | OPEN   | Z       | Z | Driver disabled by default         |
| OPEN  | H      | H       | L | Actively drive bus High by default |

When the receiver enable pin,  $\overline{RE}$ , is logic low, the receiver is enabled. When the differential input voltage defined as  $V_{ID} = V_A - V_B$  is positive and higher than the positive input threshold,  $V_{IT+}$ , the receiver output, R, turns high. When  $V_{ID}$  is negative and lower than the negative input threshold,  $V_{IT-}$ , the receiver output, R, turns low. If  $V_{ID}$  is between  $V_{IT+}$  and  $V_{IT-}$  the output is indeterminate.

When  $\overline{RE}$  is logic high or left open, the receiver output is high-impedance and the magnitude and polarity of  $V_{ID}$  are irrelevant. Internal biasing of the receiver inputs causes the output to go failsafe-high when the transceiver is disconnected from the bus (open-circuit), the bus lines are shorted (short-circuit), or the bus is not actively driven (idle bus).

**Table 8-2. Receiver Function Table**

| DIFFERENTIAL INPUT           | ENABLE          | OUTPUT | RECEIVER STATE               |
|------------------------------|-----------------|--------|------------------------------|
| $V_{ID} = V_A - V_B$         | $\overline{RE}$ | R      |                              |
| $V_{ID} > V_{IT+}$           | L               | H      | Receive valid bus High       |
| $V_{IT-} < V_{ID} < V_{IT+}$ | L               | ?      | Indeterminate bus state      |
| $V_{ID} < V_{IT-}$           | L               | L      | Receive valid bus Low        |
| X                            | H               | Z      | Receiver disabled            |
| X                            | OPEN            | Z      | Receiver disabled by default |
| Open-circuit bus             | L               | H      | Fail-safe high output        |
| Short-circuit bus            | L               | H      | Fail-safe high output        |
| Idle (terminated) bus        | L               | H      | Fail-safe high output        |

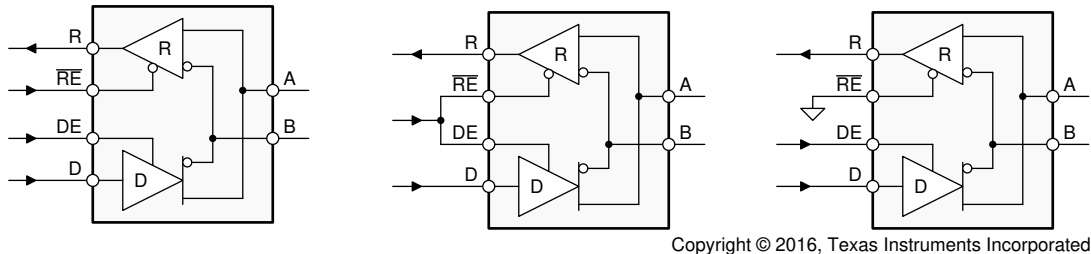
## 9 Application and Implementation

### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 9.1 Application Information

The SN65HVD1781A-Q1 is a half-duplex RS-485 transceiver commonly used for asynchronous data transmissions. The driver and receiver enable pins allow for the configuration of different operating modes.



**Figure 9-1. Half-Duplex Transceiver Configurations**

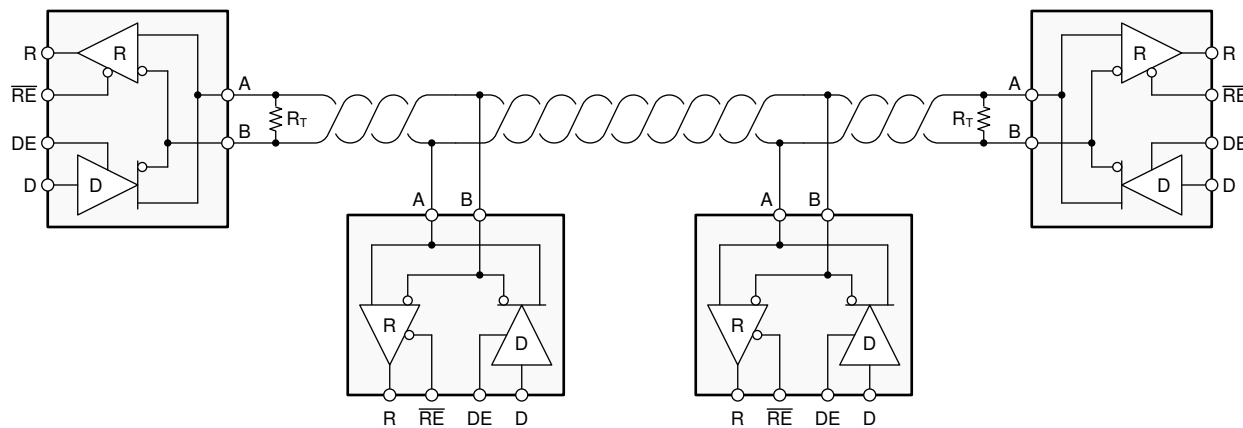
Using independent enable lines provides the most flexible control as it allows for the driver and the receiver to be turned on and off individually. While this configuration requires two control lines, it allows for selective listening into the bus traffic, whether the driver is transmitting data or not.

Combining the enable signals simplifies the interface to the controller by forming a single direction-control signal. In this configuration, the transceiver operates as a driver when the direction-control line is high, and as a receiver when the direction-control line is low.

Additionally, only one line is required when connecting the receiver-enable input to ground and controlling only the driver-enable input. In this configuration, a node not only receives the data from the bus, but also the data it sends and can verify that the correct data have been transmitted.

### 9.2 Typical Application

An RS-485 bus consists of multiple transceivers connecting in parallel to a bus cable. To eliminate line reflections, each cable end is terminated with a termination resistor,  $R_T$ , whose value matches the characteristic impedance,  $Z_0$ , of the cable. This method, known as parallel termination, allows for higher data rates over longer cable length.



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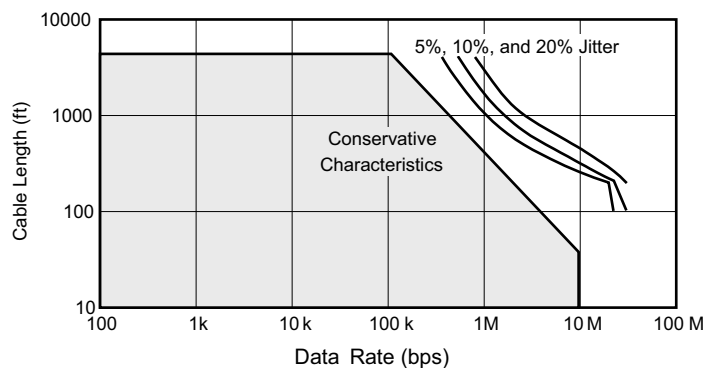
**Figure 9-2. Typical RS-485 Network With Half-Duplex Transceivers**

### 9.2.1 Design Requirements

RS-485 is a robust electrical standard suitable for long-distance networking that may be used in a wide range of applications with varying requirements, such as distance, data rate, and number of nodes.

#### 9.2.1.1 Data Rate and Bus Length

There is an inverse relationship between data rate and bus length, meaning the higher the data rate, the shorter the cable length; and conversely, the lower the data rate, the longer the cable may be without introducing data errors. While most RS-485 systems use data rates between 10 kbps and 100 kbps, some applications require data rates up to 250 kbps at distances of 4000 feet and longer. Longer distances are possible by allowing for small signal jitter of up to 5 or 10%.

**Figure 9-3. Cable Length vs Data Rate Characteristic**

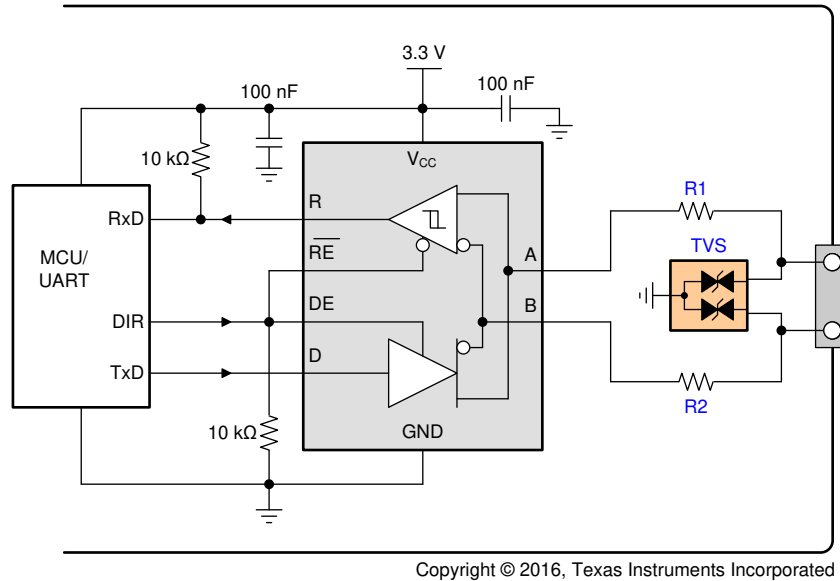
#### 9.2.1.2 Bus Loading

The RS-485 standard specifies that a compliant driver must be able to driver 32 unit loads (UL), where 1 unit load represents a load impedance of approximately 12 k $\Omega$ . Because the SN65HVD1781A-Q1 consists of 1/10 UL transceivers, it is possible to connect up to 320 receivers to the bus.

### 9.2.2 Detailed Design Procedure

Although the SN65HVD1781A-Q1 is internally protected against human-body-model ESD strikes up to  $\pm 16$  kV, additional protection against higher-energy transients can be provided at the application level by implementing external protection devices.

Figure 9-4 shows a protection circuit intended to withstand  $\pm 8$ -kV IEC ESD (per IEC 61000-4-2) as well as  $\pm 4$ -kV EFT (per IEC 61000-4-4).



**Figure 9-4. RS-485 Transceiver with External Transient Protection**

**Table 9-1. Bill of Materials**

| DEVICE | FUNCTION                                 | ORDER NUMBER       | MANUFACTURER |
|--------|------------------------------------------|--------------------|--------------|
| XCVR   | RS-485 Transceiver                       | SN65HVD1781A-Q1    | TI           |
| R1, R2 | 10-Ω, Pulse-Proof Thick-Film Resistor    | CRCW0603010RJNEAHP | Vishay       |
| TVS    | Bidirectional 600-W Transient Suppressor | SMBJ43CA           | Littelfuse   |

### 9.2.2.1 Stub Length

When connecting a node to the bus, the distance between the transceiver inputs and the cable trunk, known as the stub, should be as short as possible. Stubs present a non-terminated piece of bus line which can introduce reflections as the length of the stub increases. As a general guideline, the electrical length, or round-trip delay, of a stub should be less than one-tenth of the rise time of the driver, thus giving a maximum physical stub length as shown in Equation 1.

$$L_{\text{stub}} \leq 0.1 \times t_r \times v \times c \quad (1)$$

where

- $t_r$  is the 10/90 rise time of the driver
- $c$  is the speed of light ( $3 \times 10^8$  m/s)
- $v$  is the signal velocity of the cable or trace as a factor of  $c$

### 9.2.2.2 Receiver Failsafe

The differential receivers of the SN65HVD1781A-Q1 has receiver input thresholds that are offset so that receiver output state is known for the following three fault conditions:

- Open bus conditions, such as a disconnected connector
- Shorted bus conditions, such as cable damage shorting the twisted-pair together
- Idle bus conditions that occur when no driver on the bus is actively driving

In any of these cases, the differential receiver will output a failsafe logic High state so that the output of the receiver is not indeterminate.

Receiver failsafe is accomplished by offsetting the receiver thresholds such that the *input indeterminate* range does not include zero volts differential. In order to comply with the RS-422 and RS-485 standards, the receiver

output must output a High when the differential input  $V_{ID}$  is more positive than 200 mV, and must output a Low when  $V_{ID}$  is more negative than -200 mV. The receiver parameters which determine the failsafe performance are  $V_{IT(+)}$ ,  $V_{IT(-)}$ , and  $V_{HYS}$  (the separation between  $V_{IT(+)}$  and  $V_{IT(-)}$ ). As shown in the [Section 6.6](#) table, differential signals more negative than -200mV will always cause a Low receiver output, and differential signals more positive than 200 mV will always cause a High receiver output.

When the differential input signal is close to zero, it is still above the maximum  $V_{IT(+)}$  threshold of -35 mV, and the receiver output will be High. Only when the differential input is more than  $V_{HYS}$  below  $V_{IT(+)}$  will the receiver output transition to a Low state. Therefore, the noise immunity of the receiver inputs during a bus fault condition includes the receiver hysteresis value,  $V_{HYS}$ , as well as the value of  $V_{IT(+)}$ .

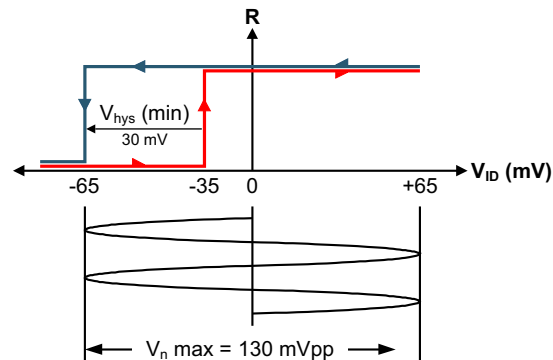
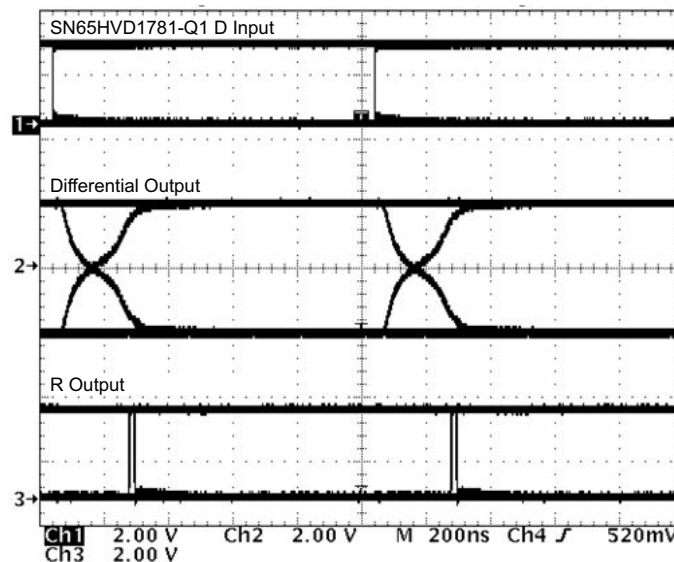


Figure 9-5. Noise Immunity Under Bus Fault Conditions

### 9.2.3 Application Curve



1-Mbps Operation

Figure 9-6. SN65HVD1781A-Q1 PRBS Data Pattern

## 10 Power Supply Recommendations

To ensure reliable operation at all data rates and supply voltages, each supply should be buffered with a 100-nF ceramic capacitor located as close to the supply pins as possible. The TPS7A6150-Q1 is a linear voltage regulator suitable for the 5-V supply.

## 11 Layout

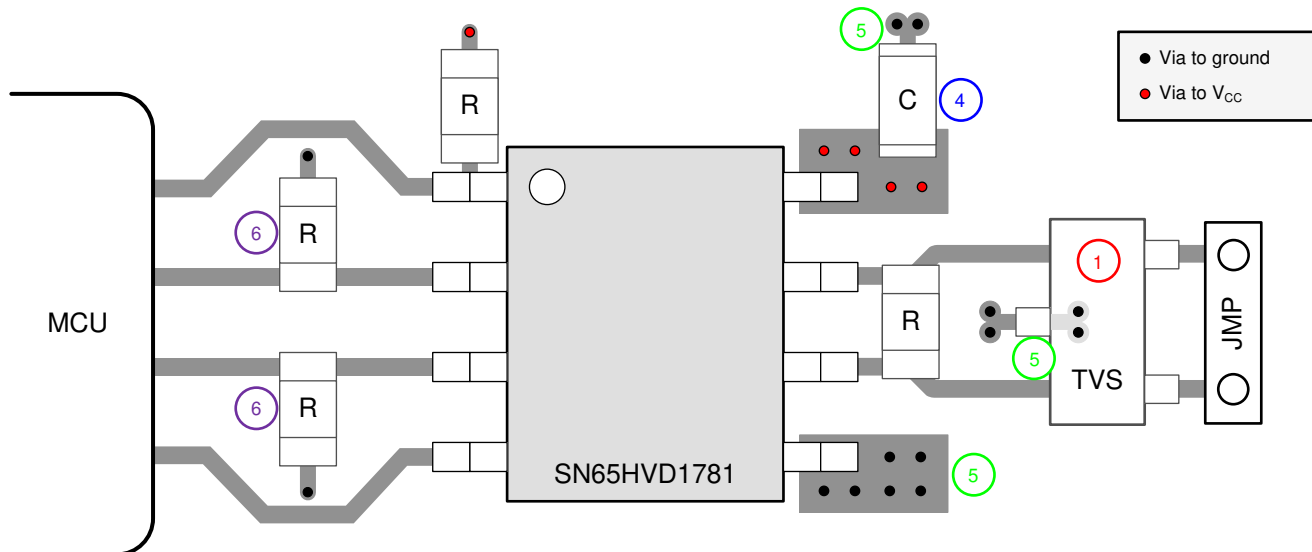
## 11.1 Layout Guidelines

On-chip IEC-ESD protection is good for laboratory and portable equipment but often insufficient for EFT and surge transients occurring in industrial environments. Therefore robust and reliable bus node design requires the use of external transient protection devices.

Because ESD and EFT transients have a wide frequency bandwidth from approximately 3 MHz to 3 GHz, high-frequency layout techniques must be applied during PCB design.

1. Place the protection circuitry close to the bus connector to prevent noise transients from entering the board.
2. Use  $V_{CC}$  and ground planes to provide low-inductance. High-frequency currents follow the path of least inductance and not the path of least impedance.
3. Design the protection components into the direction of the signal path. Do not force the transient currents to divert from the signal path to reach the protection device.
4. Apply 100-nF to 220-nF bypass capacitors as close as possible to the  $V_{CC}$  pins of the transceiver, UART, or controller ICs on the board.
5. Use at least two vias for  $V_{CC}$  and ground connections of bypass capacitors and protection devices to minimize effective via inductance.
6. Use 1-k $\Omega$  to 10-k $\Omega$  pullup and pulldown resistors for enable lines to limit noise currents in these lines during transient events.
7. While pure TVS protection is sufficient for surge transients up to 1 kV, higher transients require metal-oxide varistors (MOVs) which reduce the transients to a few hundred volts of clamping voltage, and transient blocking units (TBUs) that limit transient current to less than 1 mA.

## 11.2 Layout Example



### Figure 11-1. Half-Duplex Layout Example

## 12 Device and Documentation Support

### 12.1 Device Support

### 12.2 Documentation Support

#### 12.2.1 Related Documentation

For related documentation see the following:

- [RS-485 Half-Duplex Evaluation Module](#)
- [SN65HVD17xx Fault-Protected RS-485 Transceivers With Extended Common-Mode Range](#)
- [TPS7A6xxx-Q1 300-mA 40-V Low-Dropout Regulator With 25-μA Quiescent Current](#)

### 12.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 12.4 Community Resources

### 12.5 Trademarks

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## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable<br>part number | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|--------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| SN65HVD1781AQDRQ1        | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 1781AQ              |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "--" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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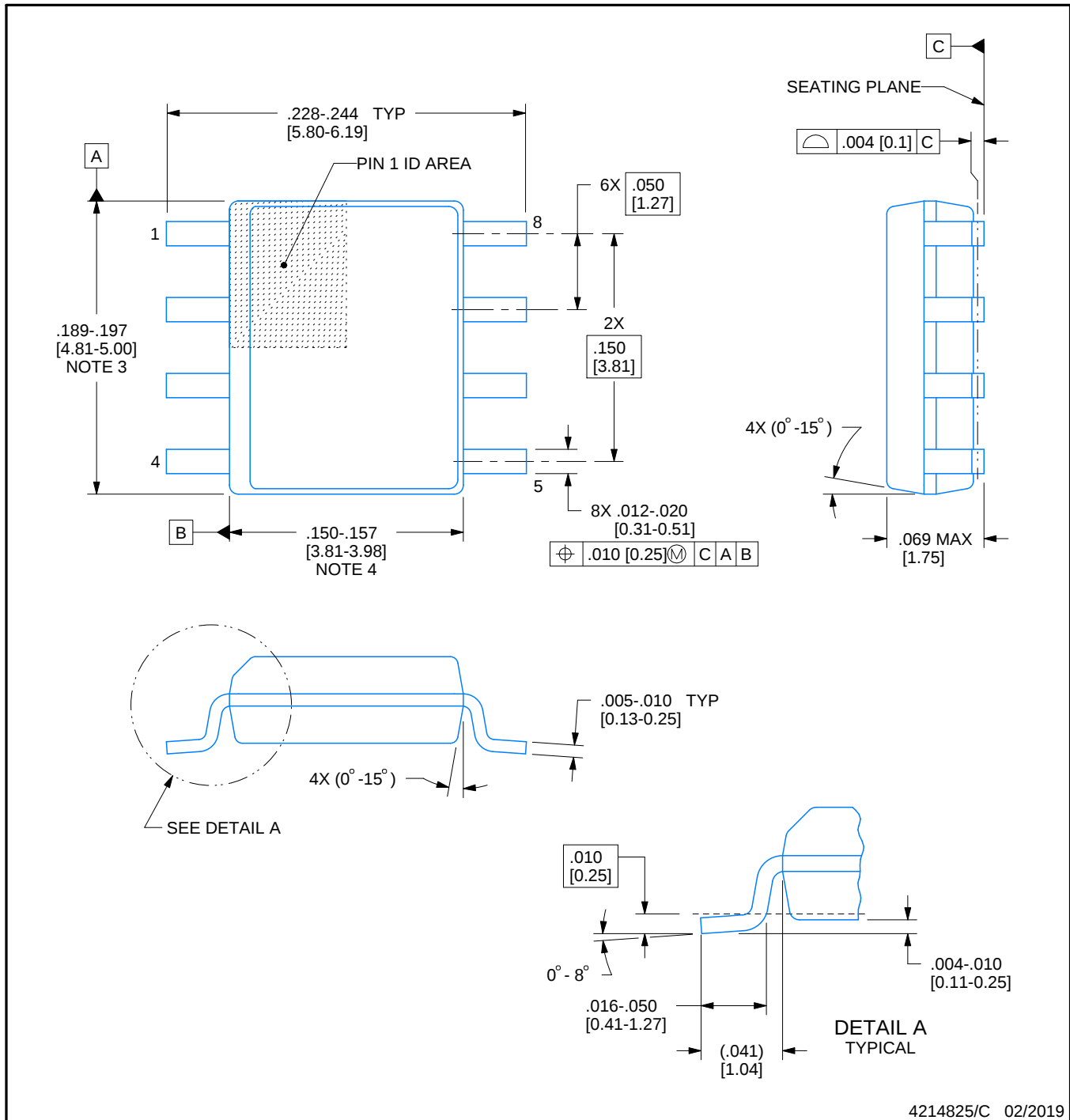


**D0008A**

# PACKAGE OUTLINE

**SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

## NOTES:

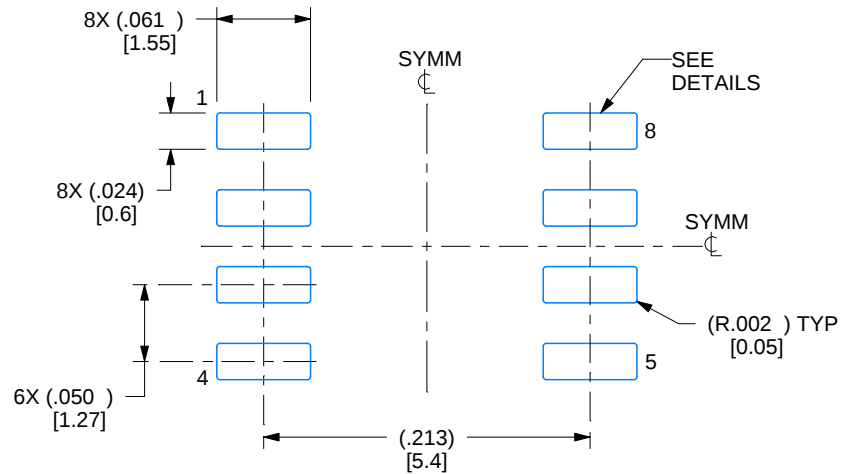
1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

# EXAMPLE BOARD LAYOUT

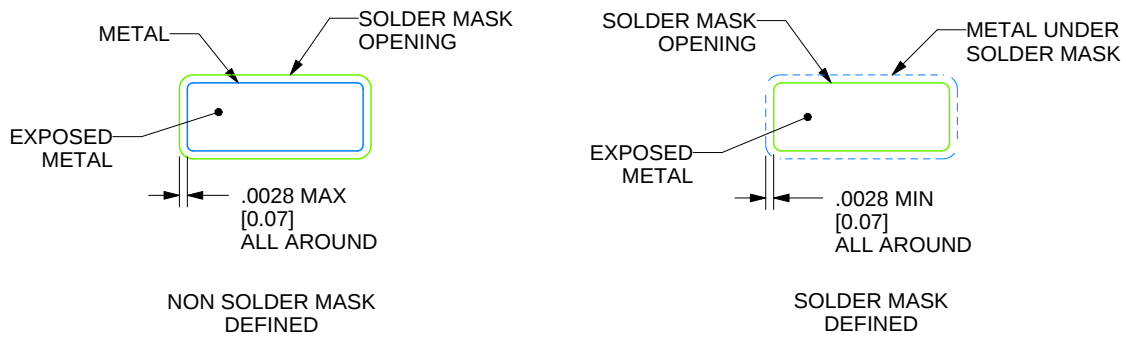
D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:8X



SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON .005 INCH [0.125 MM] THICK STENCIL  
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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